

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT2918235

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the NAME OF THE ASSIGNEE previously recorded on Reel 022871 Frame 0063. Assignor(s) hereby confirms the CORRECT NAME FOR THE ASSIGNEE IS LG ELECTRONICS INC. WITHOUT THE COMMA THAT WAS PREVIOUSLY RECORDED.
CONVEYING PARTY DATA	
Name	Execution Date
YOUNG-DAE LEE	08/14/2008
SUNG-DUCK CHUN	08/14/2008
MYUNG-CHEUL JUNG	08/14/2008
SUNG-JUN PARK	08/14/2008
PATRICK FISCHER	08/14/2008
RECEIVING PARTY DATA	
Name:	LG ELECTRONICS INC.
Street Address:	20, YOIDO-DONG, YONGDUNGPO-GU
City:	SEOUL
State/Country:	REPUBLIC OF KOREA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12293805
CORRESPONDENCE DATA	
Fax Number:	(213)623-2211
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2136232221
Email:	MAIL_PATENT@LHLAW.COM
Correspondent Name:	LEE, HONG, DEGERMAN, KANG & WAIMEY
Address Line 1:	660 SOUTH FIGUEROA STREET SUITE 2300
Address Line 4:	LOS ANGELES, CALIFORNIA 90017
ATTORNEY DOCKET NUMBER:	2101-3568
NAME OF SUBMITTER:	HARRY S. LEE
SIGNATURE:	/HARRY S. LEE/
DATE SIGNED:	06/27/2014
Total Attachments: 6	

PATENT

source=2101-3568_ConfirmationReceipt#page1.tif
source=2101-3568_ConfirmationReceipt#page2.tif
source=2101-3568_MarkedUp_NOR#page1.tif
source=2101-3568_MarkedUp_NOR#page2.tif
source=2101-3568_Assignment#page1.tif
source=2101-3568_Assignment#page2.tif



United States Patent and Trademark Office

Home | Site Index | Search | Guides | Contacts | eBusiness | eBiz alerts | News | Help



Electronic Patent Assignment System

Confirmation Receipt

Your assignment has been received by the USPTO.
The coversheet of the assignment is displayed below:

PATENT ASSIGNMENT

Electronic Version v1.1
Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Young-Dae LEE</td><td>08/14/2008</td></tr><tr><td>Sung-Duck CHUN</td><td>08/14/2008</td></tr><tr><td>Myung-Cheul JUNG</td><td>08/14/2008</td></tr><tr><td>Sung-Jun PARK</td><td>08/14/2008</td></tr><tr><td>Patrick FISCHER</td><td>08/14/2008</td></tr></tbody></table>	Name	Execution Date	Young-Dae LEE	08/14/2008	Sung-Duck CHUN	08/14/2008	Myung-Cheul JUNG	08/14/2008	Sung-Jun PARK	08/14/2008	Patrick FISCHER	08/14/2008	
Name	Execution Date												
Young-Dae LEE	08/14/2008												
Sung-Duck CHUN	08/14/2008												
Myung-Cheul JUNG	08/14/2008												
Sung-Jun PARK	08/14/2008												
Patrick FISCHER	08/14/2008												
RECEIVING PARTY DATA													
<table border="1"><tr><td>Name:</td><td>LG Electronics, Inc.</td></tr><tr><td>Street Address:</td><td>20, Yoido-dong, Yongdungpo-gu</td></tr><tr><td>City:</td><td>Seoul</td></tr><tr><td>State/Country:</td><td>REPUBLIC OF KOREA</td></tr></table>	Name:	LG Electronics, Inc.	Street Address:	20, Yoido-dong, Yongdungpo-gu	City:	Seoul	State/Country:	REPUBLIC OF KOREA					
Name:	LG Electronics, Inc.												
Street Address:	20, Yoido-dong, Yongdungpo-gu												
City:	Seoul												
State/Country:	REPUBLIC OF KOREA												
PROPERTY NUMBERS Total: 1													
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12293805</td></tr></tbody></table>	Property Type	Number	Application Number:	12293805									
Property Type	Number												
Application Number:	12293805												
CORRESPONDENCE DATA													
Fax Number: (213)623-2211													
Correspondence will be sent via US Mail when the fax attempt is unsuccessful.													
Phone: 213-623-2221													

Email:	patent@lhlaw.com
Correspondent Name:	Lee,Hong,Degerman,Kang & Waimey
Address Line 1:	660 S. Figueroa Street
Address Line 2:	Suite 2300
Address Line 4:	Los Angeles, CALIFORNIA 90017

ATTORNEY DOCKET NUMBER:	2101-3568
NAME OF SUBMITTER:	Harry S. Lee
Signature:	/Harry S.Lee/
Date:	06/24/2009

Total Attachments: 2 source=2101-3568_Assignment#page1.tif source=2101-3568_Assignment#page2.tif

RECEIPT INFORMATION	
EPAS ID:	PAT913116
Receipt Date:	06/24/2009
Fee Amount:	\$40

[Return to home page](#)

| [.HOME](#) | [INDEX](#) | [SEARCH](#) | [eBUSINESS](#) | [CONTACT US](#) | [PRIVACY STATEMENT](#)

ASSIGNMENT

(1-8) <i>Insert Name(s) of Inventor(s)</i>	(1) Young-Dae LEE	(5)
	(2) Sung-Duck CHUN	(6)
	(3) Myung-Cheul JUNG	(7)
	(4) Sung-Jun PARK	(8)
	(5) FISCHER, Patrick	

In consideration of the sum of one dollar (\$1.00) and other good and valuable considerations paid to each of the undersigned, the undersigned agree(s) to assign, and hereby does assign, transfer and set over to

(9) <i>Insert name of Assignee</i>	(9) LG ELECTRONICS INC.
(10) <i>Insert state of Incorporation of Assignee</i>	(10) Republic of Korea
(11) <i>Insert address of Assignee</i>	(11) 20, Yoido-Dong, Yongdungpo-Gu, Seoul, 150-010, Korea

(hereinafter designated as the Assignee) the entire worldwide right, title and interest in the invention known as

(12) <i>Insert identification of Invention, such as Title, Case Number or Foreign Application Number</i>	(12) METHOD OF TRANSMITTING/RECEIVING LTE SYSTEM INFORMATION IN A WIRELESS COMMUNICATION SYSTEM
--	--

for which the undersigned has (have) executed an application for patent in the United States of America and all patent applications in foreign countries corresponding thereto or based thereon.

(13) <i>Insert Date of Signing of Application</i>	(13) August 14, 2008
---	----------------------

1) The undersigned agree(s) to execute all papers necessary in connection with any original, reissue, divisional and continuing United States and foreign applications for the above-identified invention and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed any agreement in conflict herewith.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed any agreement in conflict herewith.

Attorney Docket No.:

The undersigned hereby appoints the **ATTORNEYS ASSOCIATED WITH CUSTOMER NO. 035884** the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: <u>August 14, 2008</u>	Signature of Inventor <u>[Signature]</u>
Date: <u>Aug. 14, 2008</u>	Signature of Inventor <u>[Signature]</u>
Date: <u>August 14, 2008</u>	Signature of Inventor <u>J.P.M.S.</u>
Date: <u>2008. 8. 14</u>	Signature of Inventor <u>[Signature]</u>
Date: <u>August 14, 2008</u>	Signature of Inventor <u>[Signature]</u>